

TPC Large Prototype (LP) Beam Test

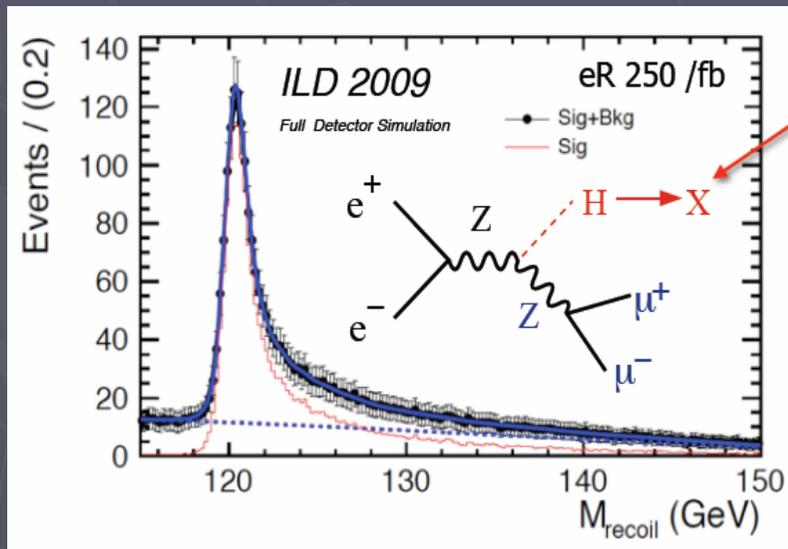
**IWLC2010
20 October 2010
Geneva**

**Takeshi MATSUDA
For
LC TPC collaboration**

Tracking at ILC: High Momentum Resolution

ILC-RDR
LDC LOI

1. Higgs recoil mass: $e^+e^- \rightarrow ZH (Z \rightarrow \mu\mu/ee) + X$:
The beam energy spread dominates when $\delta(1/pt) \leq 5 \times 10^{-5}$.
2. Slepton and the LSP masses through the end point measurement:
 σ_M (Momentum resolution) $\sim \sigma_M$ (Parent mass) at 1 ab^{-1}
when $\delta(1/pt) \leq 5 \times 10^{-5}$
3. E_{cm} determination from $e^+e^- \rightarrow \mu^+\mu^-(\gamma)$
4. Rare decay Br ($H \rightarrow \mu\mu$) in $e^+e^- \rightarrow ZH$ and $H\nu\nu$:



Higgs mass expected for ILD



MPGD TPC: Goals

$\sigma_{r\phi} \leq 100 \mu\text{m}$
points/track ~ 200
Lever arm $\sim 1.5 \text{ m}$
High B Field 3.5T (no ExB)
Alignment and corrections

$$\delta(1/p_t) \leq 5 \times 10^{-5}$$

Specifications of TPC at ILC (ILD)

TABLE 4.3-5

Goals for performance and design parameters for an LCTPC with standard electronics.

Size	$\phi = 3.6\text{m}, L = 4.3\text{m}$ outside dimensions
Momentum resolution (3.5T)	$\delta(1/p_t) \sim 9 \times 10^{-5}/\text{GeV}/c$ TPC only ($\times 0.4$ if IP incl.)
Momentum resolution (3.5T)	$\delta(1/p_t) \sim 2 \times 10^{-5}/\text{GeV}/c$ (SET+TPC+SIT+VTX)
Solid angle coverage	Up to $\cos \theta \simeq 0.98$ (10 pad rows)
TPC material budget	$\sim 0.04X_0$ to outer fieldcage in r $\sim 0.15X_0$ for readout endcaps in z
Number of pads/timebuckets	$\sim 1 \times 10^6/1000$ per endcap
Pad size/no.padrows	$\sim 1\text{mm} \times 4\text{--}6\text{mm}/\sim 200$ (standard readout)
σ_{point} in $r\phi$	$< 100\mu\text{m}$ (average over $L_{\text{sensitive}}$, modulo track ϕ angle)
σ_{point} in rz	~ 0.5 mm (modulo track θ angle)
2-hit resolution in $r\phi$	~ 2 mm (modulo track angles)
2-hit resolution in rz	~ 6 mm (modulo track angles)
dE/dx resolution	$\sim 5\%$
Performance	$> 97\%$ efficiency for TPC only ($p_t > 1\text{GeV}/c$), and $> 99\%$ all tracking ($p_t > 1\text{GeV}/c$) [83]
Background robustness	Full efficiency with 1% occupancy, simulated for example in Fig. 4.3-4(right)
Background safety factor	Chamber will be prepared for $10 \times$ worse backgrounds at the linear collider start-up

TPC R&D by LC TPC Collaboration

Demonstration Phase: Small prototype tests

Provide a basic evaluation of the properties of **MPGD TPC** by using small prototypes, demonstrate that the requirement of the point resolution may be achieved.

Consolidation Phase: Large prototype tests (2008-)

Design, build and operate a "Large Prototype" using the EUDET facility at DESY comparing technologies and demonstrating the momentum resolution in a way.

Design Phase: ILD LOI → ILD DBD →

Start working on engineering design of TPC at ILC (ILD).

(LC TPC collaboration: MOU)

Perform beam tests at all stages.

Options of MPGD TPC for LC

Based on the studies with small MPGD TPC Prototypes

Analog TPC:

- (1) Multi layer GEM + Narrow (1mm wide) pad readout:
Defocusing by multilayer GEM**
- (2) MicroMEGAS + Resistive anode pad readout:
Widening signal by a resistive anode**
- (3) Multilayer GEM + Timepix
A good efficiency for primary electrons
→ A larger pixel size, but still a higher granularity.**

Digital TPC:

- (4) Ingrid (MicroMEGAS) Timepix: (also the GEM-like structure)
Digital → Free from the gas gain fluctuation
(More information from primary electrons)
Some improvement in the position resolution
Need measurement for long drifts**

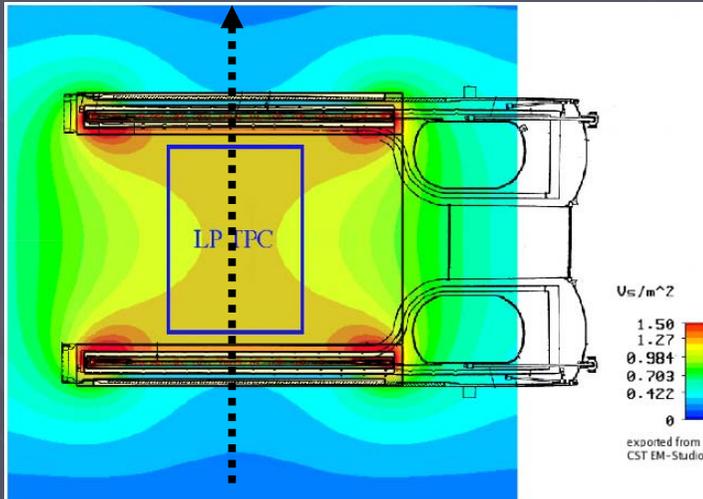
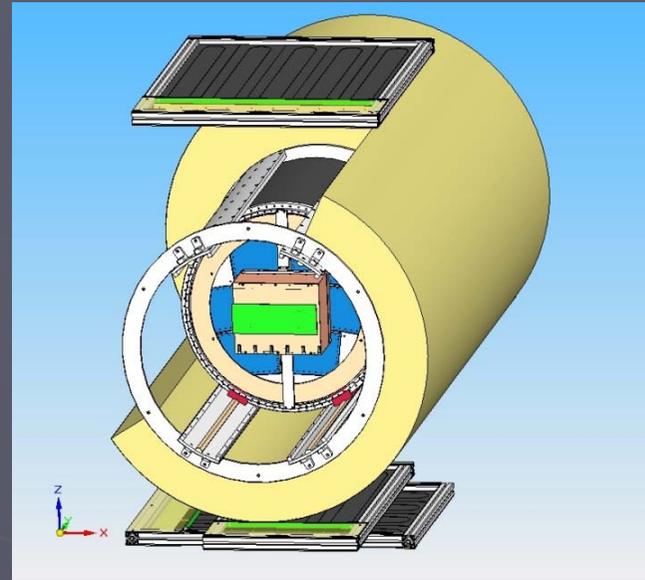
EUDET TPC Facility at DESY Hamburg

PCMAG:

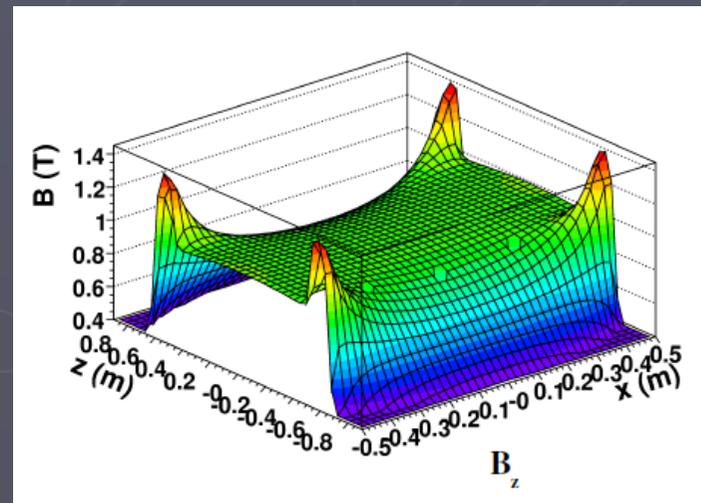
Open SC magnet (1T) at
DEST T24-1 test beam
(electron: 1 - 6GeV/c).
Coil/cryostat of 20%X0.

On a moving stage (2010)

Also with a cosmic trigger.

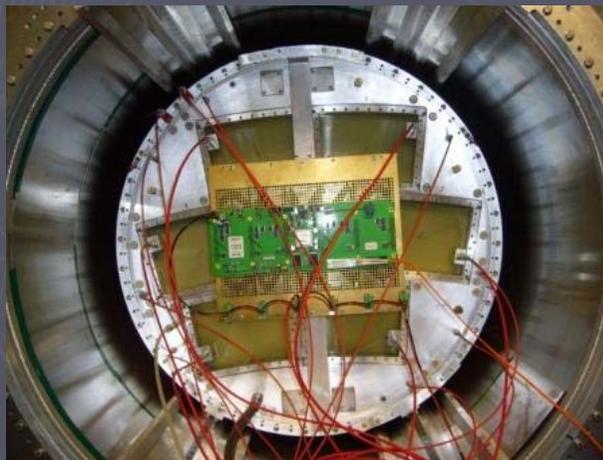


Non-uniform magnetic field
(on purpose)

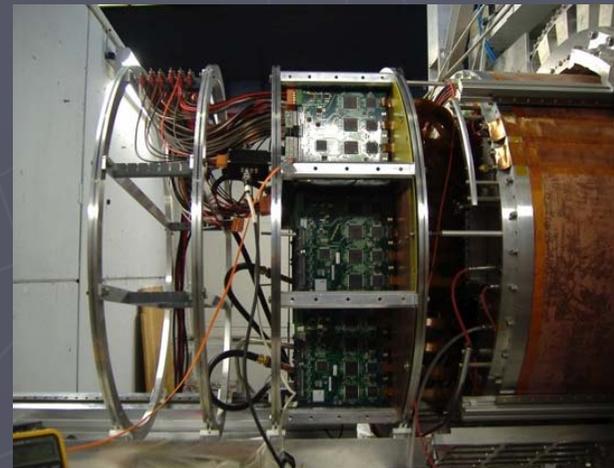


A field model based on a precision field
measurement made in 2007

TPC Large Prototype Beam Test (LP1) at DESY T24-1 Beam Line



**With a MicroMEGAS module
readout by T2K electronics**

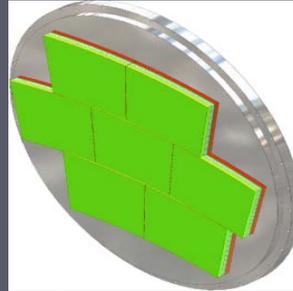


**With three GEM modules readout by
PCA16-ALTRO electronics**

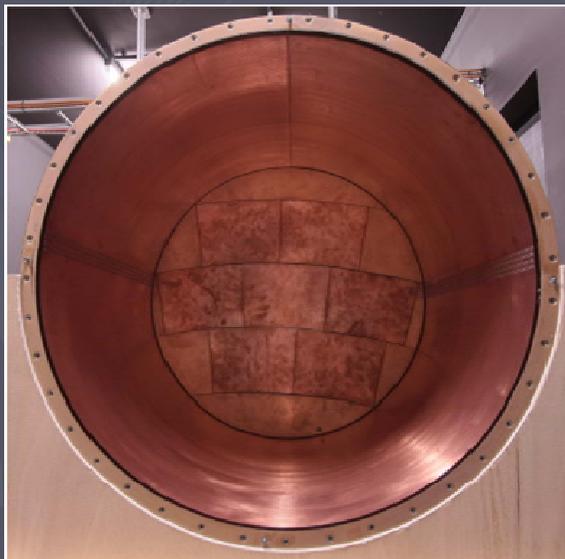
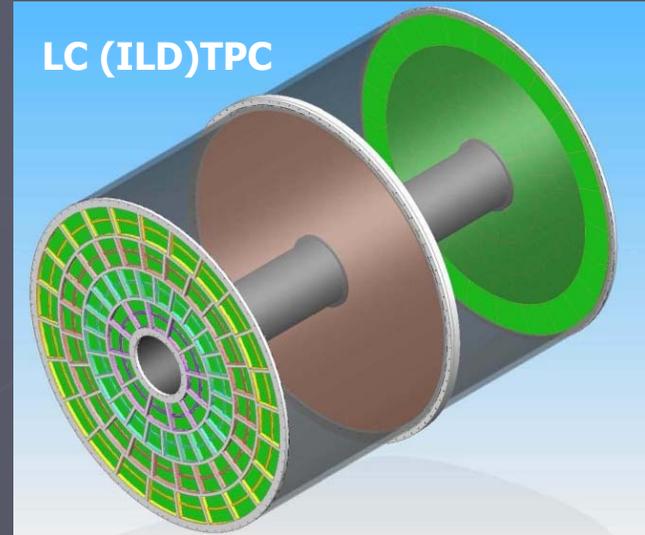
TPC Large Prototype (LP1)



LP1 Endplate



LP endplate:
A part of LC TPC
endplate



LP1 Field cage of $L=61$ cm, $D=72$ cm.
1.2% X0 thick (Up to around 20kV).

A cathode with laser patterns for calibration.

A gas system monitoring temperature,
pressure, gas flow, O_2 and H_2O . (Use
premixed gases.)

DAQ and slow monitor

TPC Large Prototype Tests: LP1

2008:

Nov-Dec MicroMEGAS modle w/ resistive anode (T2K electronics)

2009:

Feb-Apr 3 Asian GEM Modules w/o Gating GEM (3,000ch ALTRO electronics)

Apr TDC electronics with an Asian GEM Module

Apr-May Maintenance of PCMAG

May-Jun MicroMEGAS w/ two different resistive anodes (New T2K electronics)
Setup and test of laser-cathode calibration

Jun GEM+Timepix (Bonn)

Jun Installation of PCMAG moving stage and SiTR support

July TDC electronics with an Asian GEM module

ALTRO electronics study w/ an Asian GEM module

July-Aug Full installation of PCMAG moving stage

Aug MicroMegas w/o resistive anode with laser-cathode calibration

Sept A Bonn GEM module (A small aria GEM with ALTRO electronics)

Nov MicroMEGAS with SiTR

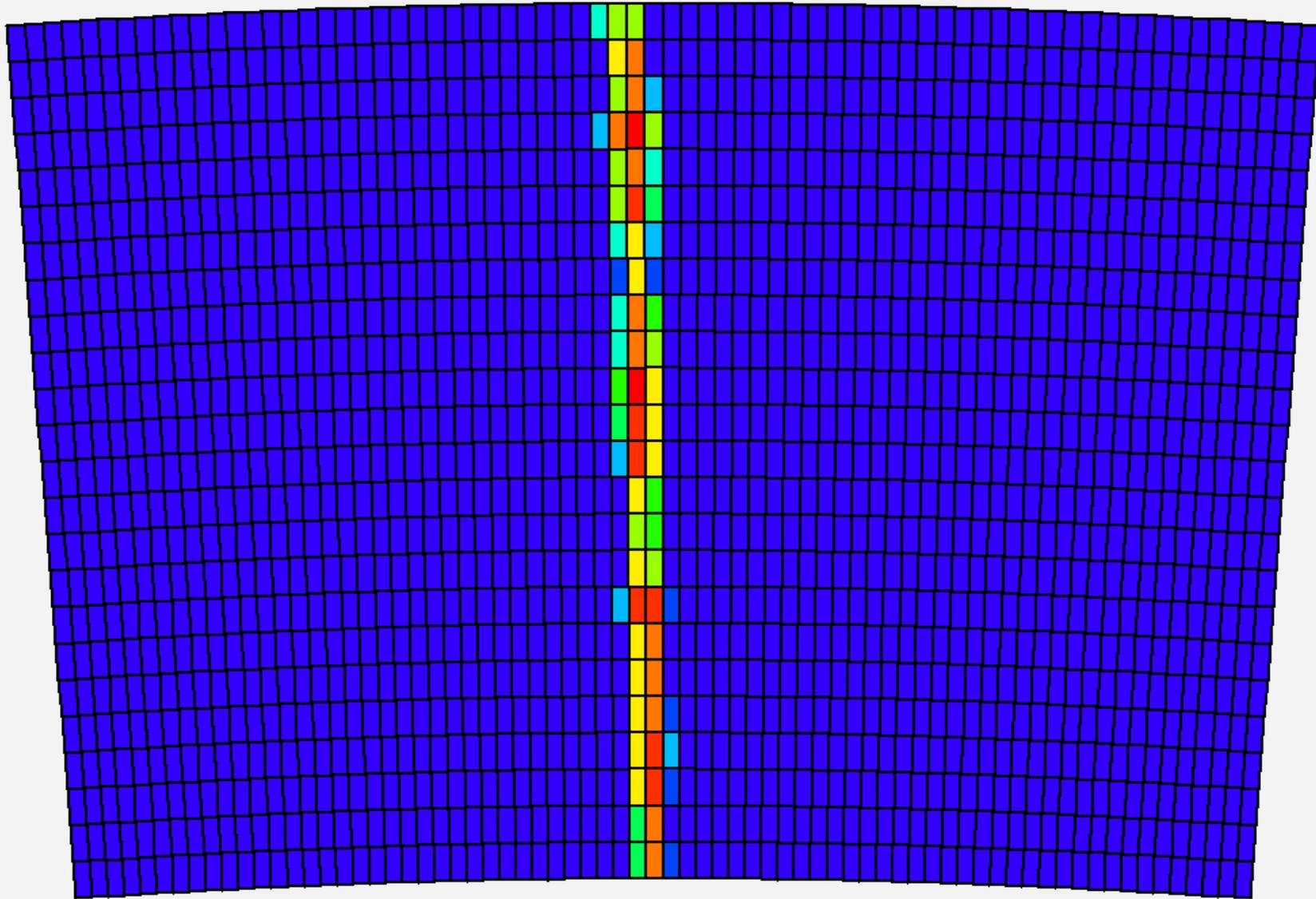
Dec MicroMEGAS with the carbon loaded kapton resistive anode.

2010:

March MicroMEGAS using PCMAG movable table.

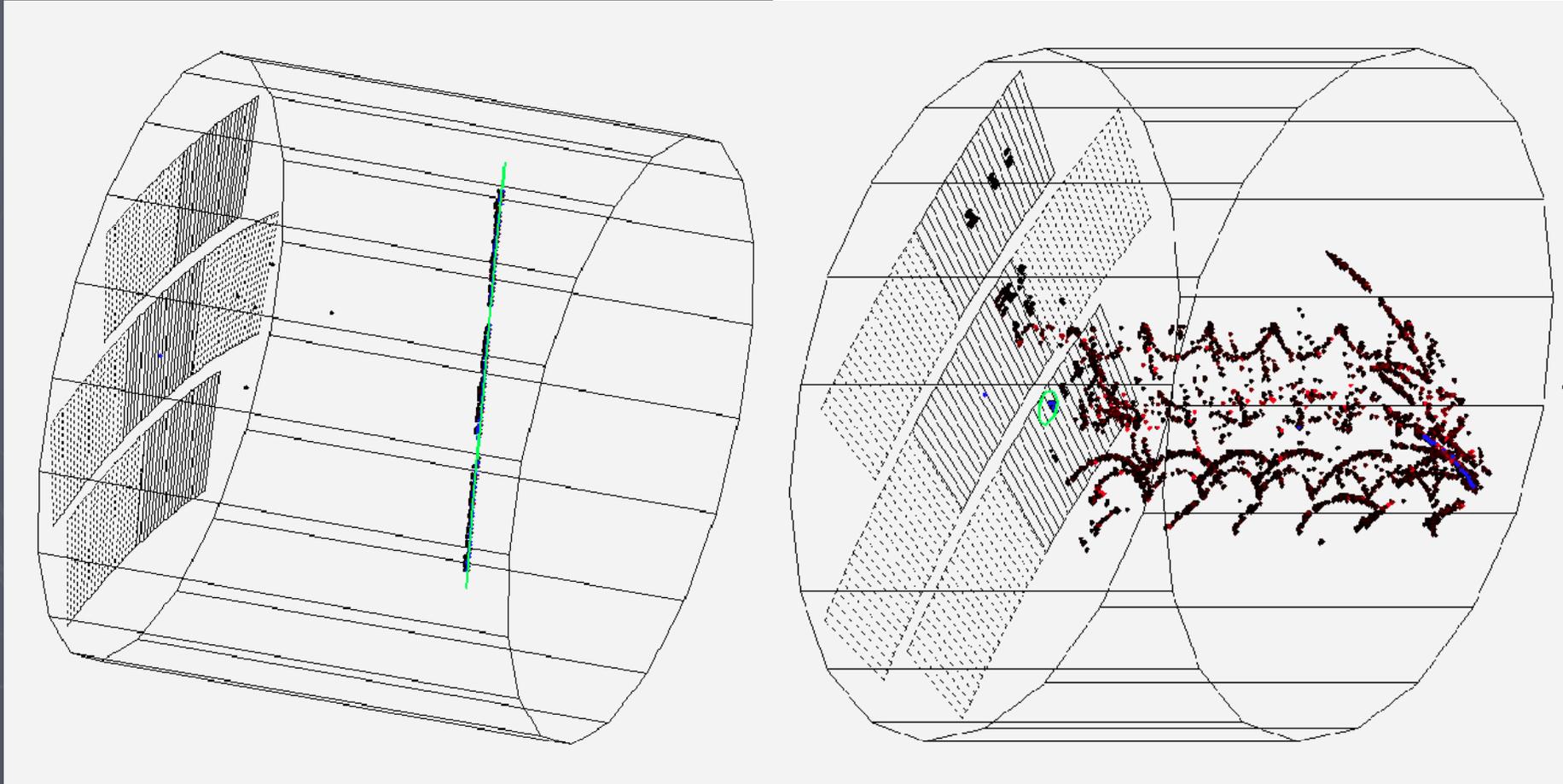
March and Sept 3 Asian GEM modules w/ gating GEM or a field shaper) using the PCMAG movable table (7616ch ALTRO electronic)

LP1 TPC Events with a MicroMEGAS module



A MicroMGAS module: 24 rows x 72 pads (2.7-3.2 mm wide and 7 mm long)

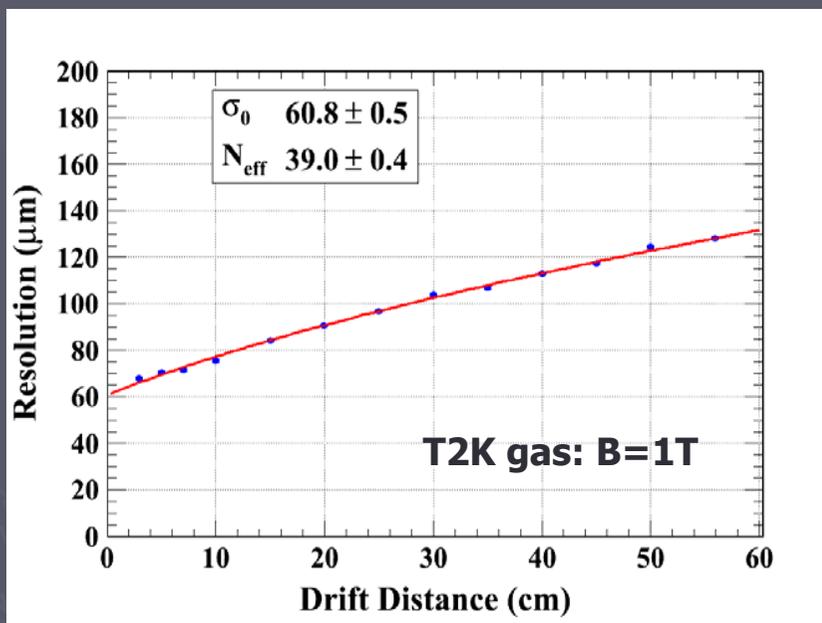
Events of 5GeV/c Electron Beam LP1 TPC with Three GEM modules



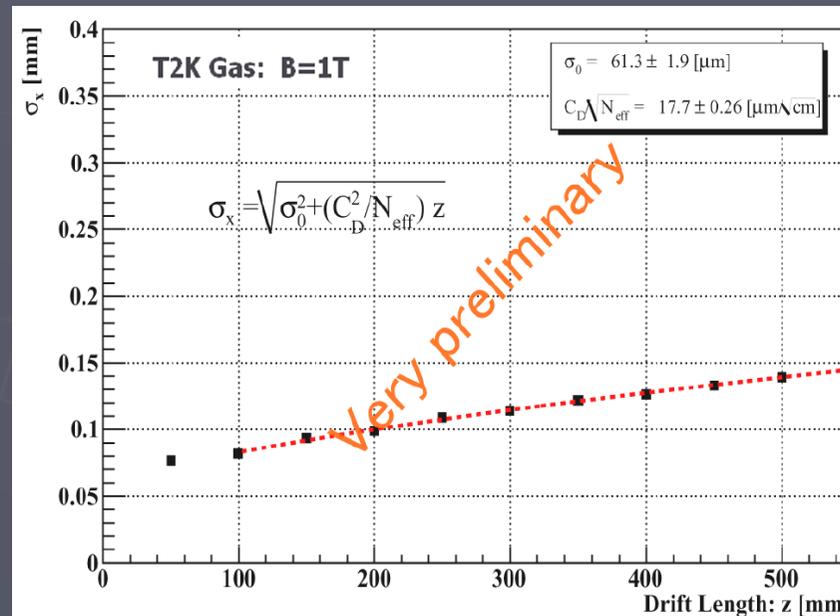
A typical single track event (left), and an event with many low-energy curling tracks from the TPC cathode plane where a beam electron hits (right). Only a part of the three GEM modules are quipped with readout electronics.

TPC Large Prototype Tests: LP1 (2008-2010)

Some recent results: Point Resolutions



MicroMEGAS module with a carbon-loaded kapton resistive foil (T2K electronics)



GEM module of two layers of 100 μm GEM (PCA16-ALTRO electronics)

A point resolution of 100 μm or better for 2m drift in B=3.5T (ILD TPC)
(Actually 80 μm for the parameters obtained by MicroMEGAS)

Software Tools

Tracking software for multi-modules: **Toward Marlin TPC**

(a) YokalowMon with Track-Finding Kalman Filter Processor:

Input data: DAQ format

Use Kalman filter algorithm only in track fitting.

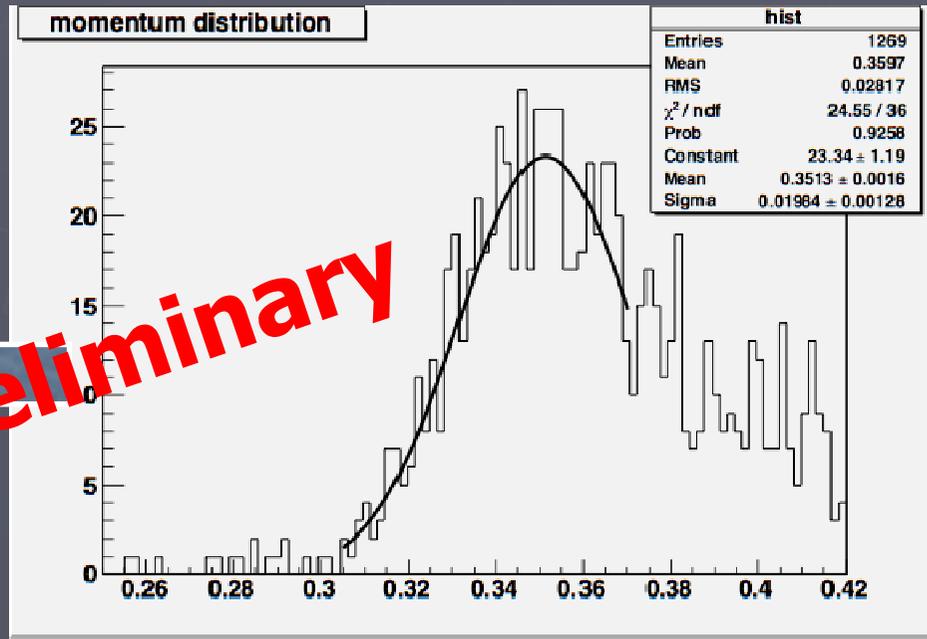
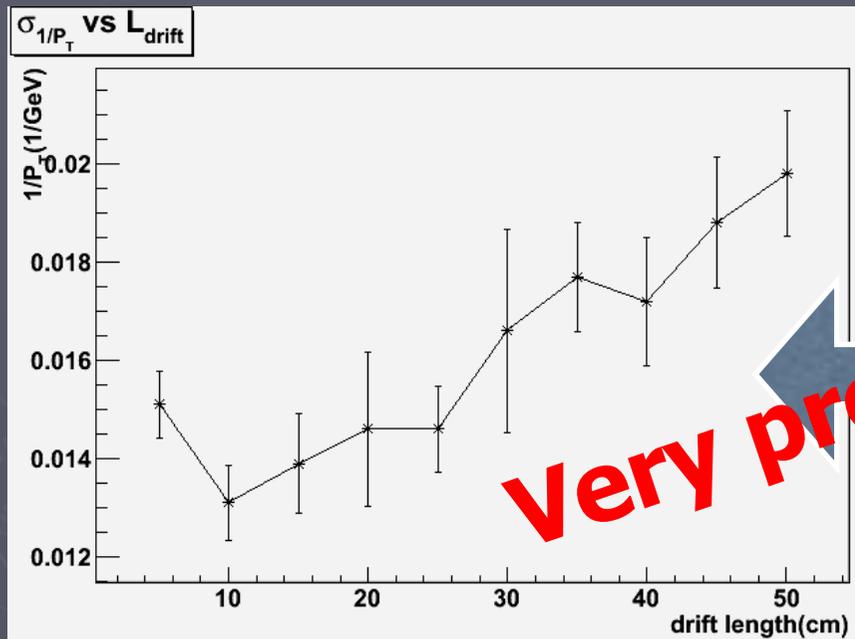
(b) Marlin TPC with Track-Making-Kalman-Filter-Processor:

Input data : LCIO format

Use Kalman filter algorithm both in track finding and track fitting .

Implementation of the non-uniform magnetic filed: Now under work!

An Example of Initial Trials of Multi-module Track Fitting by Marlin TPC



Very preliminary

Resolution of $1/P_T$

$1/P_T$ distribution

(No serious selection of tracks, no correction for module misalignment and distortion)

Point Resolution and Momentum Resolution: Current Status of TPC LP1 Beam Test

(1) Point resolution $\sigma_{r\phi}$: Demonstrated in the LP1

**GEM & MicroMEGA with analog readout
T2K gas of low diffusion (high $\omega\tau$) in high magnetic fields**

(T2K gas: Ar/CF₄(3%)/isobetaine(2%))

(2) Momentum resolution: Now!

**Corrections (Non uniformity magnetic field, alignment etc) to get
momentum resolution match to the point resolution.**

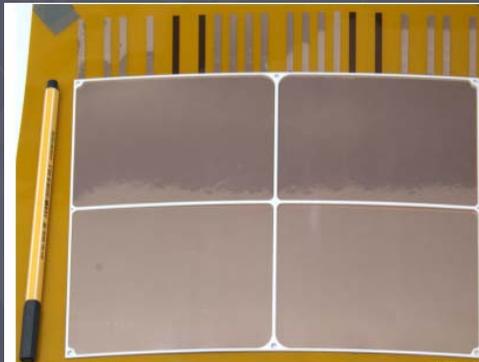
(3) Other issues:

**Other requirements
Performance of the digital TPC and others**

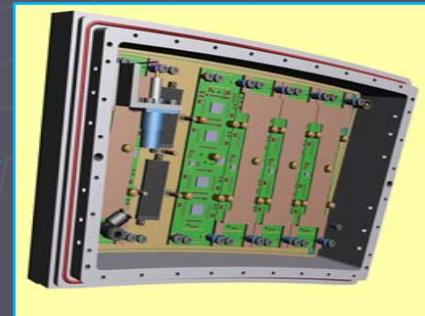
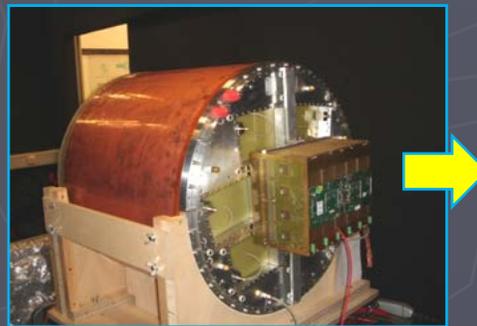
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LP1 Beam Test before 2012

2010: Nov-DEC	A prototype of DESY GEM module (A GEM module of three GEM layers supported by thin ceramic spacers)
2011: Spring	A module with 8 Ingrid Timepix (Octopus) The first MicroMEGAS module with compact T2K electronics More DESY GEM modules
June-Dec	PCMAG modification for "Liq. He less"
2012:	7 MicroMEGAS modules with compact T2K electronics

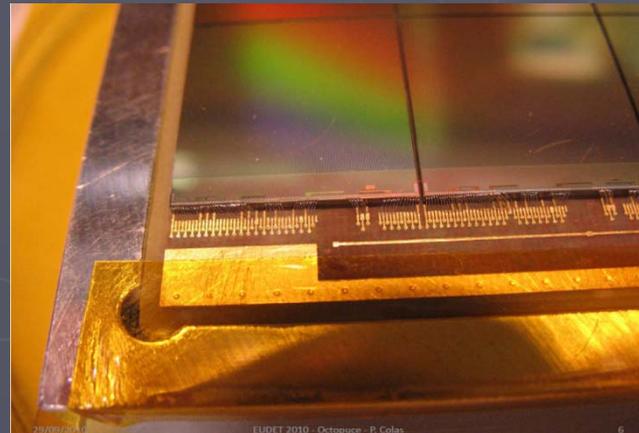
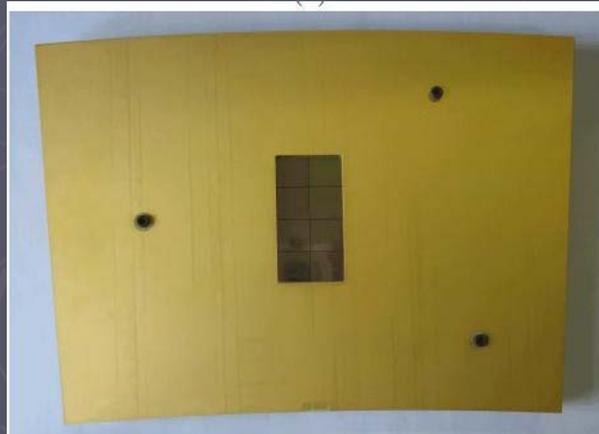
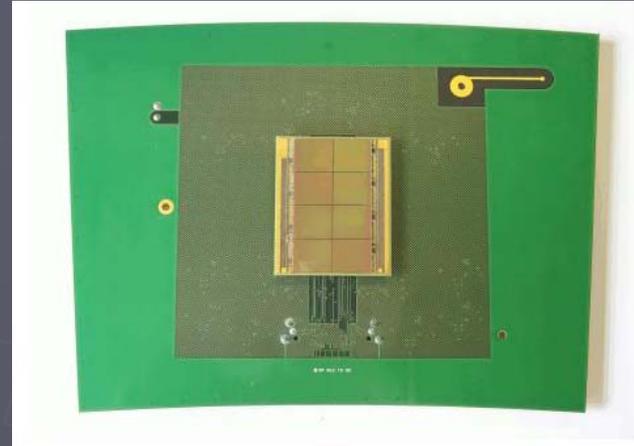


A GEM glued on a thin ceramic Spacer (DESY GEM module)



A MicroMEGAS module with compact T2K electronics

LP1 Module with 8 Ingrid Timepix: Octopus



To be the first test of the Digital TPC module in LP

PCMAG Modification in AIDA/DESY/KEK

PCMAG without Liquid He (2011)

**Safe, easy and efficient operation (by R&D groups)
Portability to bring to any beam line in the world**

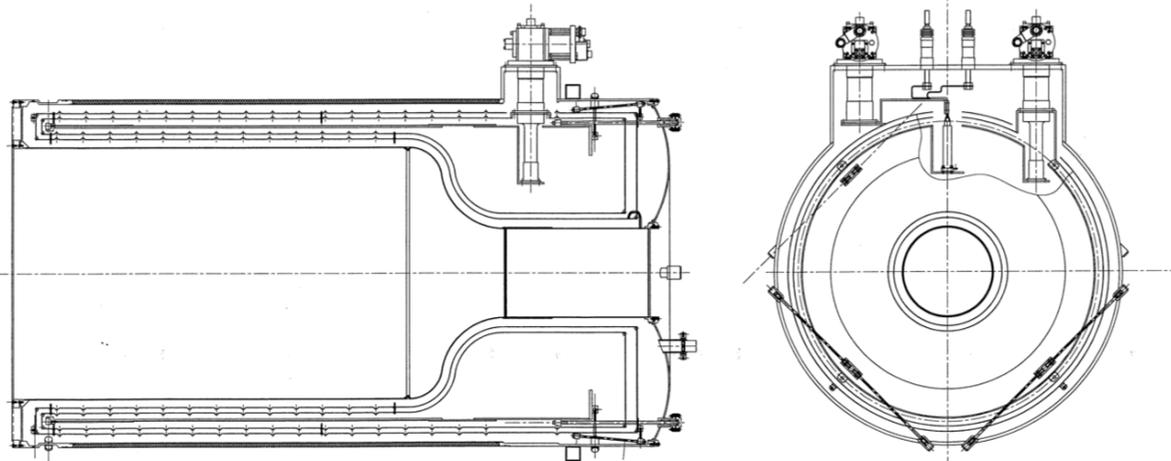
Save Liquid He (1000L for initial cooling and 250L/week)

Add two cryo-modules (for coil and current leads)

Standard way of operation (no persistent current mode)

Cost of modification: AIDA+DESY+KEK

Tentative Schedule: ready in the beginning of 2012 (6 months)



PCMAG with two cryo-coolers (Current plan)

TPC Large Prototype Beam Test from 2012: LP1 →LP2

Advanced endplate:

Material thickness $< 25\%X_0$ for PFA

the requirement of $15\%X_0$ may be relaxed to 20-30% based on a recent PFA study of jet energy resolution.

Thin endplate:

Light mechanical-structure of endplate.

LP Modules of high density, low power electronics to match with smaller pads (1 x 4mm): S-ALTRO electronics

Issue of power delivery, power pulsing, and cooling (2-phase CO₂) with S-ALTRO mounted in the back of each module (include an option of direct mounting on the backside of the pad plane)

Ion Feed back and Ion disks:

Estimate distortion due to the ion disks

→ Most probably needs a gating device

Options of gating device: Wire gating, GEM gating and others.

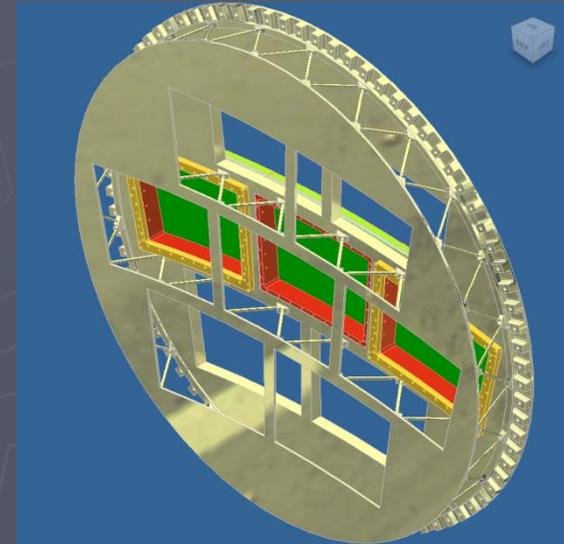
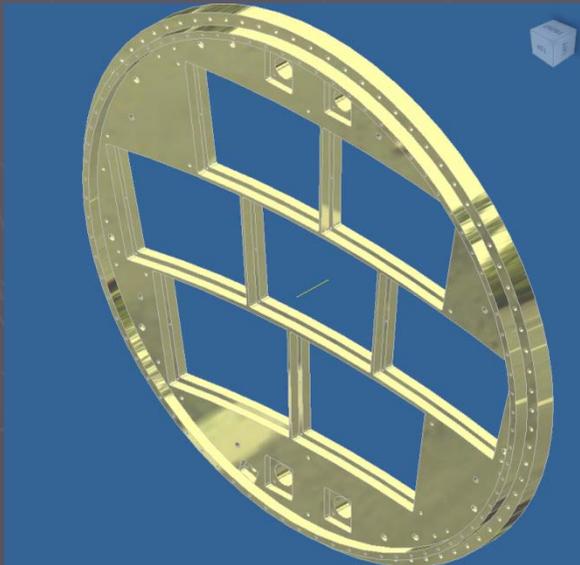
Advanced Endplate: Thinning Endplate Structure (Mechanical)

Demonstration at Large Prototype (LP2)

Compares to **18.87 kg** aluminum for the current LP1 endplate.

2009-03-04, reported on design of the hybrid (aluminum/carbon fiber) design:
7.35 kg Aluminum, **1.29 kg** carbon, for LP1, 0.072 X_0 .

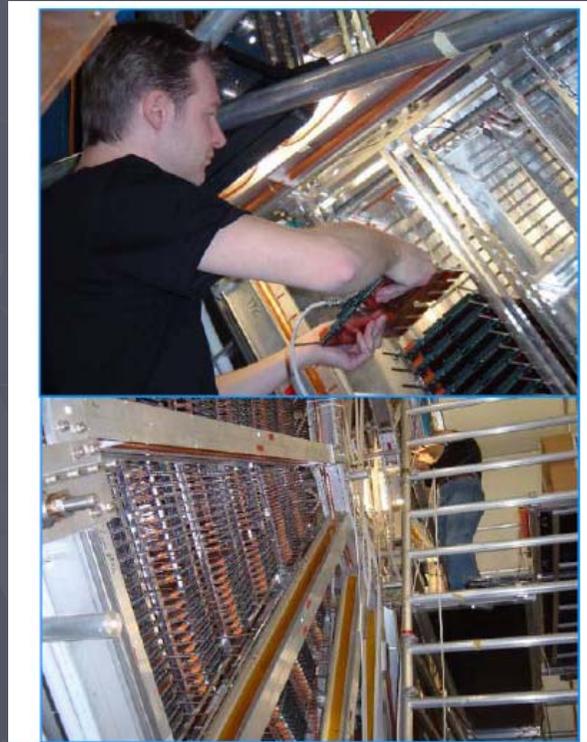
Mass is currently 12kg, but will be reduced to about **8 kg** after thinning the uninstrumented areas.



Also the second filed cage

Advanced Endplate: S-ALTRO

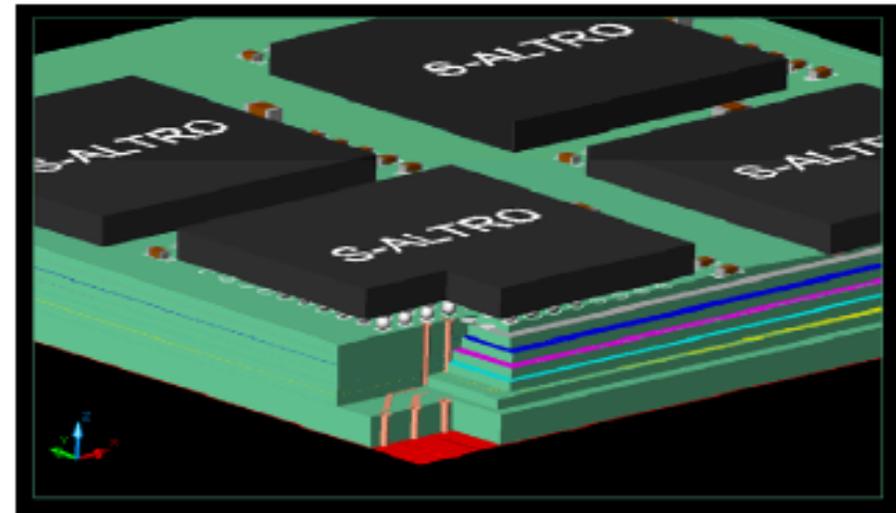
High density, low power, low material electronics for TPC



Musa / CERN

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ALICE TPC



The S-ALTRO team at CERN

P. Aspell, H. Franca Santos, E. Garcia,
A. Junique, M. Mager, C. Patauner,
A. Ur Rehman, L. Musa

ILC (ILD) TPC

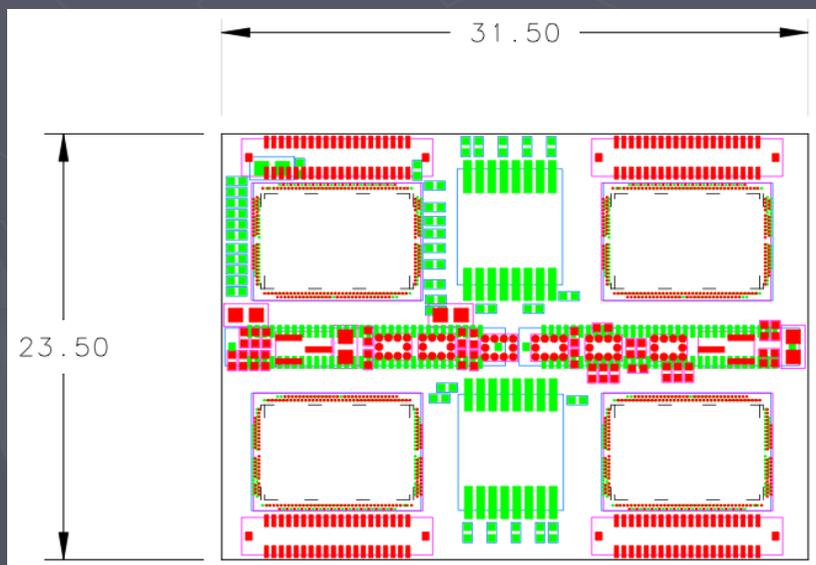
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Advanced Endplate: S-Altro16 in MCM

Avoid the risk of direct bump bonding (at least in the R&D stage) with the relaxed material budget.

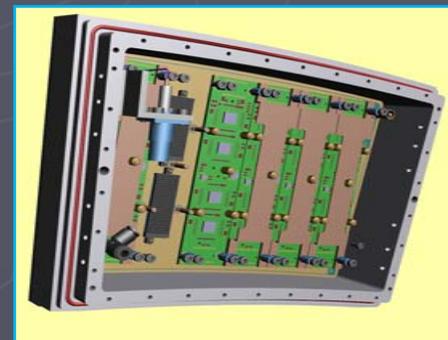
Components in red are facing the pad module whereas components in green are on the opposite side. (Note that the chip frame is the occupied bond-area and not the die size)

The dimensions of the board is compatible with a pad size of $1 \times 6 \text{ mm}^2$. Need 64ch chip for $1 \times 4 \text{ mm}$ pads in future.



S-Altro16 MCM

S-ALTRO will be used both for GEM and Micromegas



Advanced Endplate: Cooling

Preliminary Design Consideration for ILC TPC

Advantage of thin piping (high pressure)



TPC end plate cooling tube routing

Possible layout of the 6 loops option

Liquid supply ring (~5mm ID)

Vapor return ring (~8mm ID)

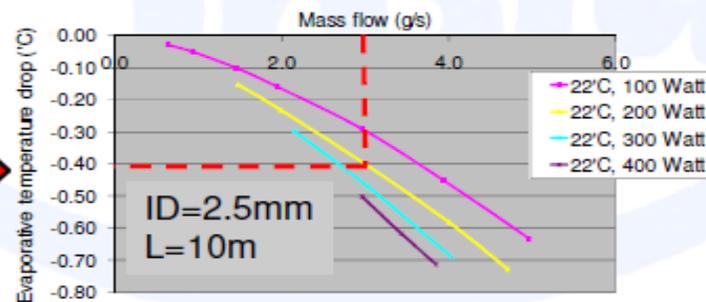
Cooling tube (~2.5mm ID)

Inlet capillary (~1mm ID)
Restriction for flow distribution

Similar to AMS-TTCS

	Qty Frames / loop	Heat load per loop (W)	Tube length (m)	Inner diameter (mm)
1 loop	200	1000	48m	6.2
2 loops	100	500	24m	4.3
4 loops	50	250	12m	3
6 loops	34	171	8m	2.2

AMS test data (2001)
0.4°C temperature gradient



Advanced Endplate: Test with a Pad PCB Model

Test:

Power switching

Power delivery

Cooling:

Thermo-mechanical test

In a high field (DESY 5T magnet, PCMAG, etc.)

Pad PCB model with FPGA

**Realistic design of pad PCB with all components
64ch S-ALTROs replaced by proper FPGAs and
OP amp/ADC as current load and heat source.**

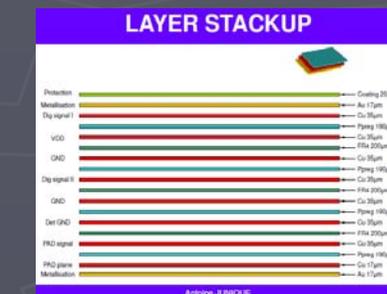
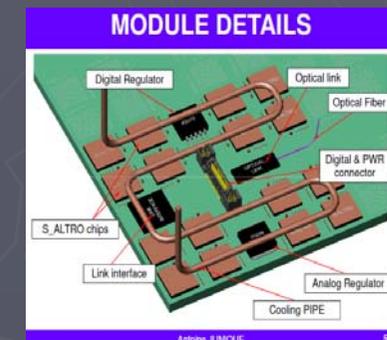
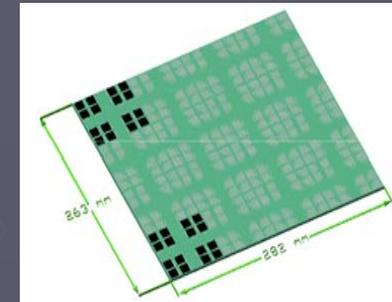
Connect pads to the FPGA analog outputs

Try cooling by the 2-phase CO2 cooling (NIKHEF)

Test also on board software/communication

Test in high magnetic field

Test Schedule: 2010-2011



TPC Large Prototype Beam Test : Tentative Schedule

2010-2011	Continue LP1 at DESY to complete the measure of momentum resolution and others.
2011	PCMAG modification: Potable PCMAG without Liq. He
2012	Continue LP1 while preparing LP2 with advanced endplate at DEST T24-1 beam line.
2012-	LP2 with advanced endplate (at DESY) Possibly visit a hadron beam (10-100GeV/c) for a few months .

Some Conclusions

MPGD TPC options at ILC (ILD) TPC provide a large number of space points (200) with the excellent point resolution down to 100microns over 2m drift distance. It is a truly-visual 3D tracker works in high magnetic field providing the performance necessary for the experimentation at ILC.

The TPC Large Prototype test at DESY (LP1) by LC TPC collaboration using the EUDET facility is being carried out successfully since November 2008.

We look forward to performing momentum measurement in non uniform magnetic field of PCMAG with full length tracks in the multi modules setup in 2010-2012.

From 2012 we hopefully start the beam test (LP2) with the advanced endplate and a proper gating device. The momentum measurement will be improved using a higher energy hadron beam.